Abracon ASxxx Series of High Performance MEMS Differential Clock Oscillator

ASxxx Series of devices are miniature MEMS based, PLL clock oscillators optimized to meet the requirements of high speed serial data communication channels. These differential devices are available in single and dual output formats including CMOS, LV-PECL, LVDS, and HCSL.

Features

- Devices are available in standard pin-pin compatible [7.0 x5.0mm], [5.0x3.2mm], [3.2x2.5mm], and [2.5x2.0mm] footprints.
- Devices are Lead Free & RoHS compliant.
- Jitter optimized for high speed serial data formats.
- High Reliability, with 20 times better MTTF than quartz oscillators
- Devices operate from +2.5, to +3.6 Volt supplies
- -40 to +85C operating temperature range, and extended Automotive Grade temperature stability at -55 to +125°C, ±25ppm
- Multiple output formats: CMOS, LVPECL, LVDS, HCSL, including Dual Output configurations.
- High Stability with ± 10ppm, ±25ppm, ±50 ppm available.
- Short lead Time: 2 weeks
- Shock & Vibration Immunity MIL-STD-883
- 50 dBc Power Supply Rejection Ratio
- Field programmable production devices are available



Applications

Storage Area Networks » SATA, SAS, Fibre Channel, PCIe

Passive Optical Networks » EPON, 10G-EPON, GPON, 10G-PON

Ethernet » 1G, 10GBASE-T/KR/LR/SR, FCoE

Video » HD, SD, SDI

Application Output Configurations





0 1uE

Links and Resources- MEMS data sheets: http://www.abracon.com/oscillators.htm#memsoscoscillators.htm#memsosc:

What the ASxxx can do for your design.....

The ASxxx series saves PCB area. Combine a small device footprint and minimal external components to get the smallest solution footprint.

The ASxxx series is optimized to exceed Jitter requirements of high speed serial data formats. Integrated jitter 100KHz -20MHz < 400fs, and 200KHz - 20 MHz < 300 fs.

ASxxx series is more cost efficient vs. quartz competitors. As device dimensions shrink, quartz resonator costs increase. The 0.2 mm2 MEMS device cost decreases with package size.



Highly reliability designs such as Enterprise SSD Memory cannot meet their performance targets without highly reliable components such as the ASxxx clock oscillators.

http://www.eetimes.com/design/memory-design/4412418/W hy-flash-storage-needs-MEMS

MEMS Part Number / Key Performance list

ABRACON DIFFERENTIAL MEMS					
Supply Voltage: 2.25V to 3.6 V					
Package Sizes: ASVMP (7.0 x 5.0 x 0.85mm, ASFLMP 5.0 x 3.2 x 0.85 mm ASDMP 2.5 x 2.0 x 0.85mm & All others 3.2 x 2.5 x 0.85 mm					
Part Number	Differential Output Type	Supply Current	Frequency Range	Integrated Phase Jitter (JPH)	Stability
ASEMCLP	LVPECL	56.5mA typ		Typically,	
ASEMCLV	LVDS	29mA typ	~ 10 – 460MHz	< 400fs / (100KHz – 20MHz) and	
ASEMCHC	HCSL	40mA typ			+/-10ppm over -40 / 85C
ASEMDHC	Dual HCSL	60mA typ			
ASEMDLP	Dual LVPECL	89mA typ			050
ASEMDLV	Dual LVDS	89mA typ		< 300fs /	
ASEMP	CMOS, LVPECL, LVDS, HCSL	31mA typ 51mA typ 29mA typ 40mA typ	CMOS ~ 10 – 170MHz LVPECL/	(200KHz – 20MHz (Typical Ref 156MHz clock o/p)	+/-10ppm over
ASDMP	CMOS, LVPECL, LVDS, HCSL	31mA typ 56.5mA typ 29mA typ 40mA typ	LVPECL7 LVDS/HCSL ~10-460MHz		-20/70C and
ASFLMP	CMOS, LVPECL, LVDS, HCSL	31mA typ 51mA typ 29mA typ 40mA typ	CMOS ~ 10 - 170MHz	Typically, < 550fs / (100KHz – 20MHz)	+/-50ppm over -55/ +125C
ASVMP	CMOS, LVPECL, LVDS, HCSL	31mA typ 51mA typ 29mA typ 40mA typ	LVPECL / LVDS / HCSL ~10 - 425MHz	and < 350fs / (200KHz – 20MHz	





The Power of Linking Together